

8 Legal information

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Revision History

Date	OTP Rev / PDF Rev	OTP Changes from the first revision
Dec 28 2020	Rev A / Rev 1.0	Initial prototype release of the OTP settings
Mar 3 2021	Rev B / Rev 1.0	Production release of the OTP <ol style="list-style-type: none">1. BUCK3 Non DVS Ramp: Changed to 3.47mV/us (power up/down) from 10.42mV/us (power up/down)2. Standby PGOOD Release Delay: Changed to 400us from 300us3. LDO1 Sequence: Changed to Slot 1 from Slot 0
Sept 8 2021	Rev B / Rev 1.1	<ol style="list-style-type: none">1. Fixed typographical errors in the previously released rev G production OTP